

Description

The TLP280-4x series combine two AlGaAs infrared emitting diodes as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SO16 package.

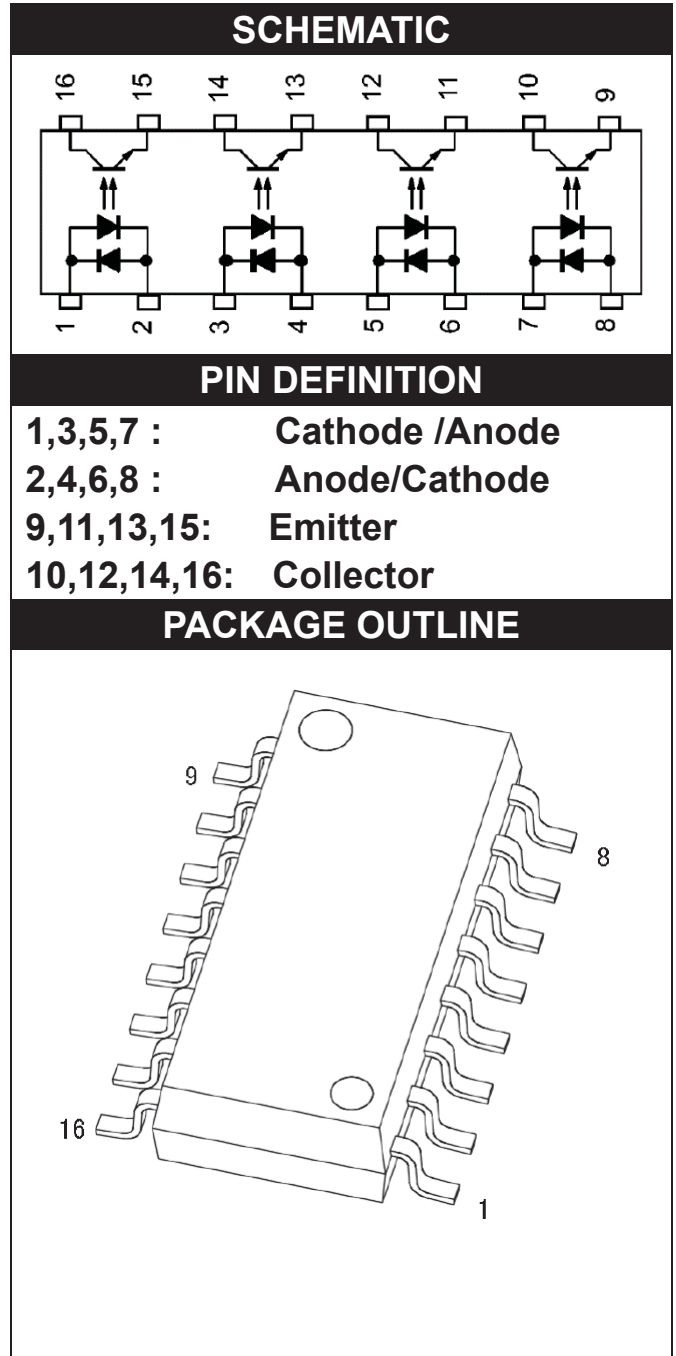
With the robust coplanar double mold structure, TLP280-4x series provide the most stable isolation feature.

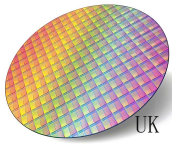
Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- AC input with transistor output
- Operating temperature range - 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1, GB8898
 - cUL- CSA Component Acceptance Service Notice No. 5A

Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment





ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	I_F	± 60	mA	
Peak Forward Current	I_{FP}	± 1	A	1
Input Power Dissipation	P_i	100	mW	
OUTPUT				
Collector - Emitter Voltage	V_{CEO}	80	V	
Emitter - Collector Voltage	V_{ECO}	6	V	
Collector Current	I_C	50	mA	
Output Power Dissipation	P_o	150	mW	
COMMON				
Total Power Dissipation	P_{tot}	200	mW	
Isolation Voltage	V_{iso}	3750	V _{rms}	2
Operating Temperature	T_{opr}	-55~110	°C	
Storage Temperature	T_{stg}	-55~125	°C	
Soldering Temperature	T_{sol}	260	°C	

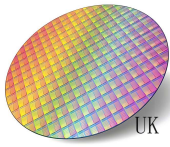
Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V _F	-	-	1.4	V	IF=10mA	
Input Capacitance	C _{in}	-	10	-	pF	V=0, f=1kHz	
OUTPUT							
Collector Dark Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0	
Collector-Emitter Breakdown Voltage	BV _{CEO}	80	-	-	V	IC=0.1mA, IF=0	
Emitter-Collector Breakdown Voltage	BV _{ECO}	6	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	280-4	CTR	50	-	600	%	IF=1mA, VCE=5V
	280-4GB		100	-	600		
CTR Symmetry		0.7	-	1.3		IF=±1mA, VCE=5V	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	-	0.07	0.2	V	IF=20mA, IC=1mA	
Isolation Resistance	R _{ISO}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C _{IO}	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)	t _r	-	7	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)	t _f	-	9	18	μs	RL=100Ω	3

Note 3. Fig.12&13

Note 4. Fig.14



CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Ambient Temperature

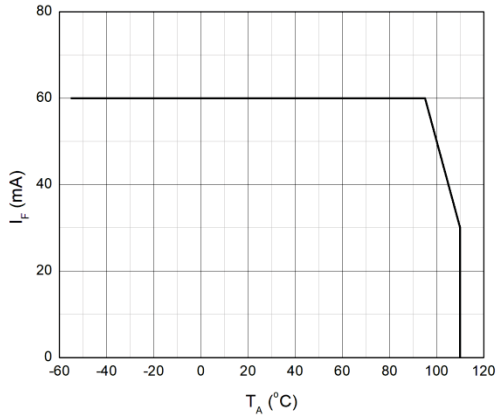


Fig.2 Collector Power Dissipation vs. Ambient Temperature

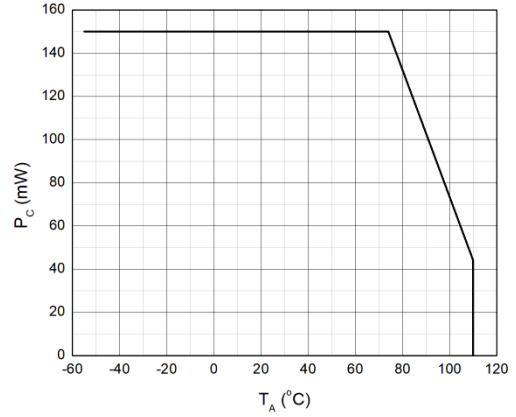


Fig.3 Forward Current vs. Forward Voltage

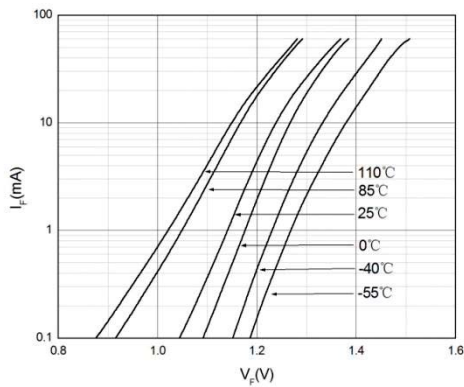


Fig.4 Collector Dark Current vs. Ambient Temperature

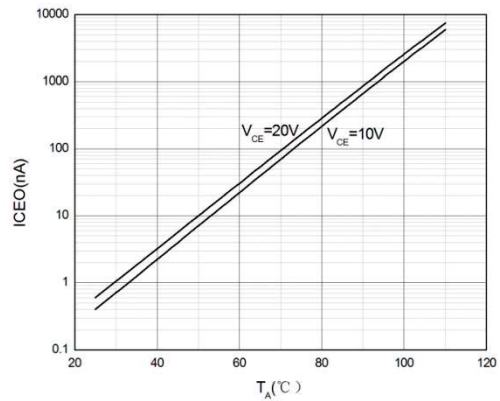


Fig.5 Collector Current vs. Collector-emitter Voltage

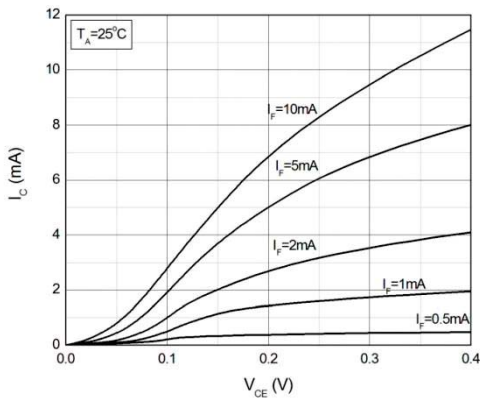
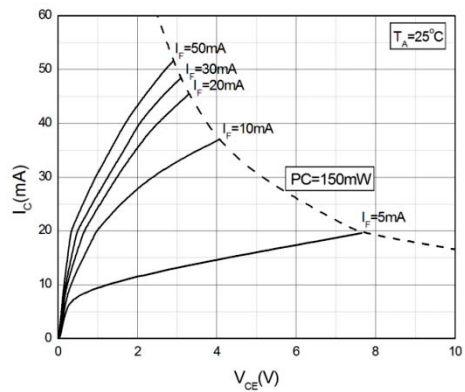
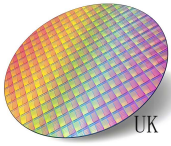


Fig.6 Collector Current vs. Collector-emitter Voltage





CHARACTERISTIC CURVES

Fig.7 Normalized Current Transfer Ratio vs. Forward Current

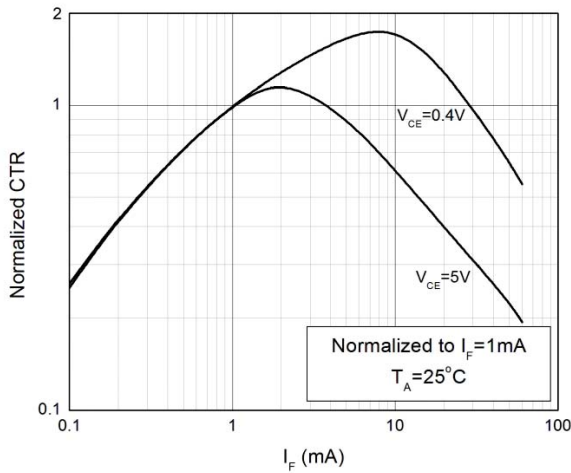


Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature

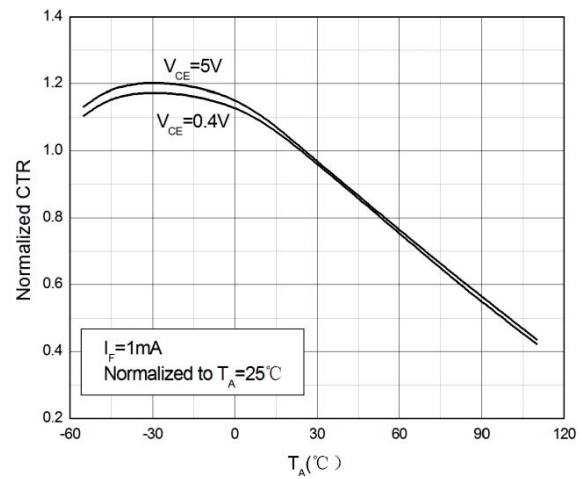


Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature

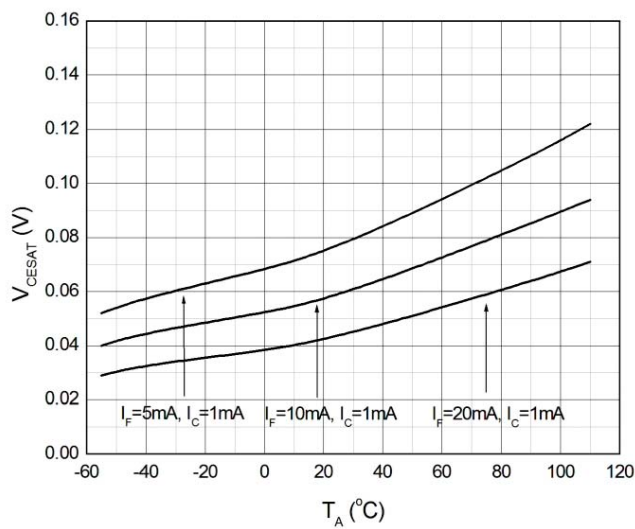


Fig.10 Switching Time vs. Load Resistance

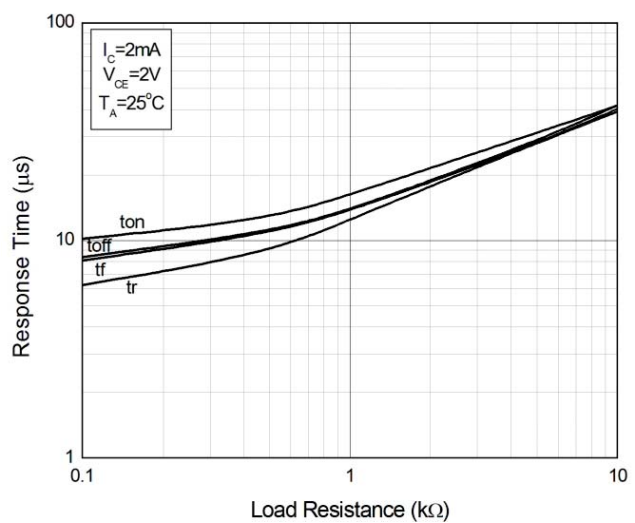
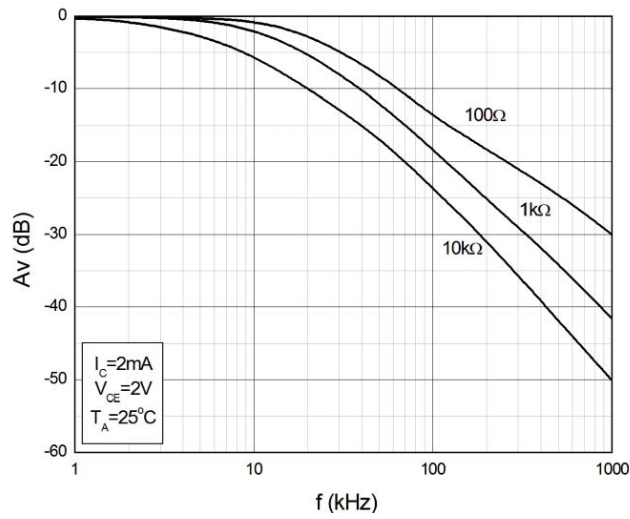


Fig.11 Frequency Response



TEST CIRCUITS

Fig.12 Test Circuits of Response Time

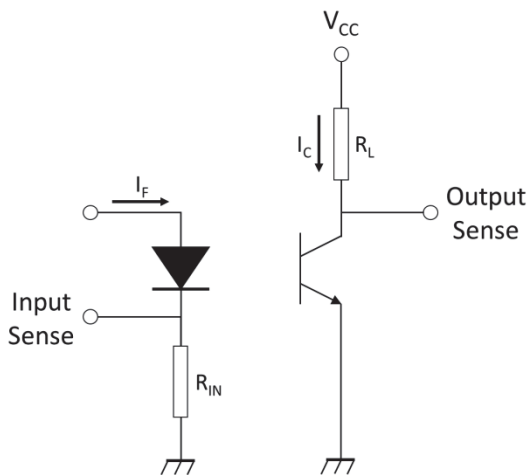


Fig.13 Curves of Response Time

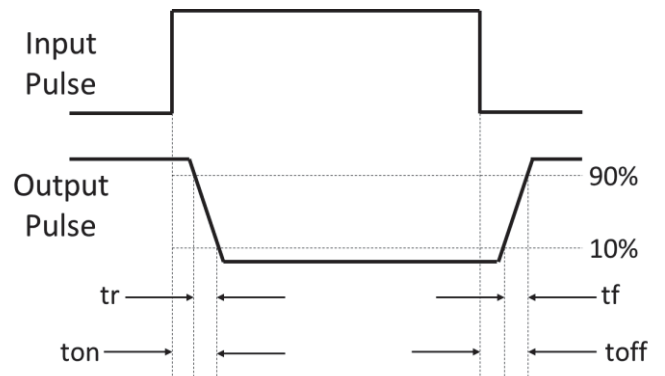
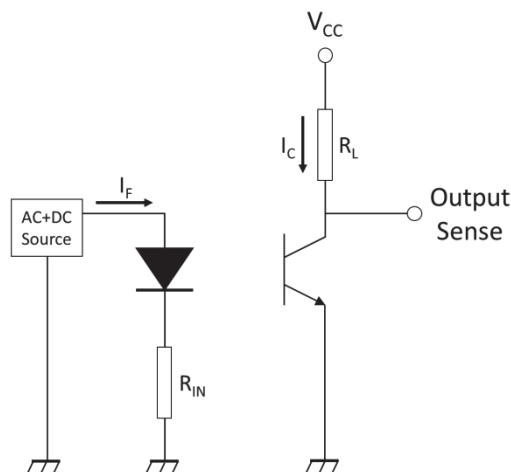
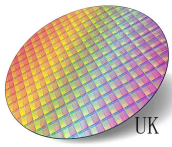
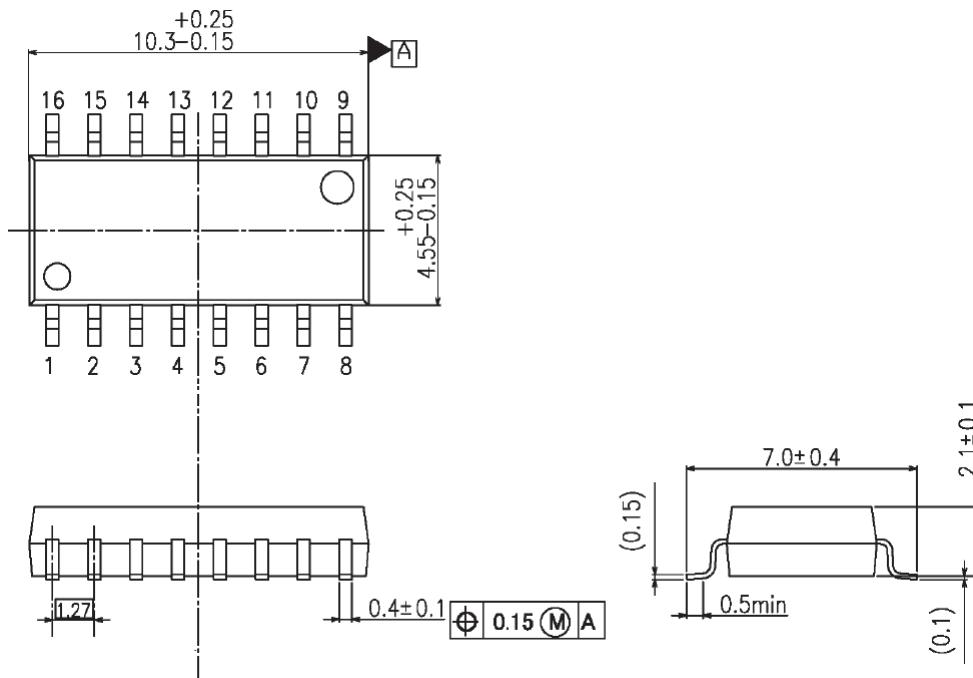


Fig.14 Test Circuits of Frequency Response

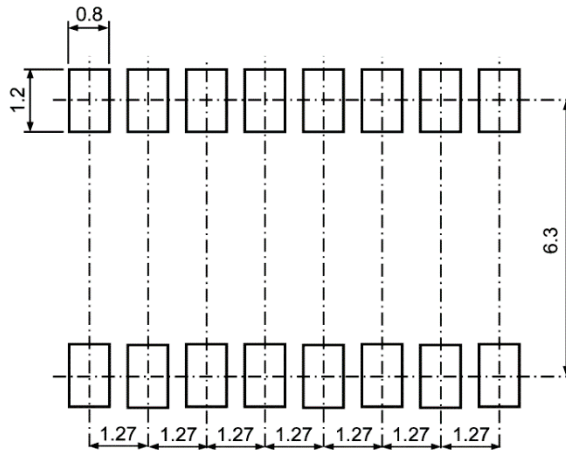


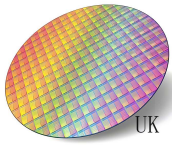


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)



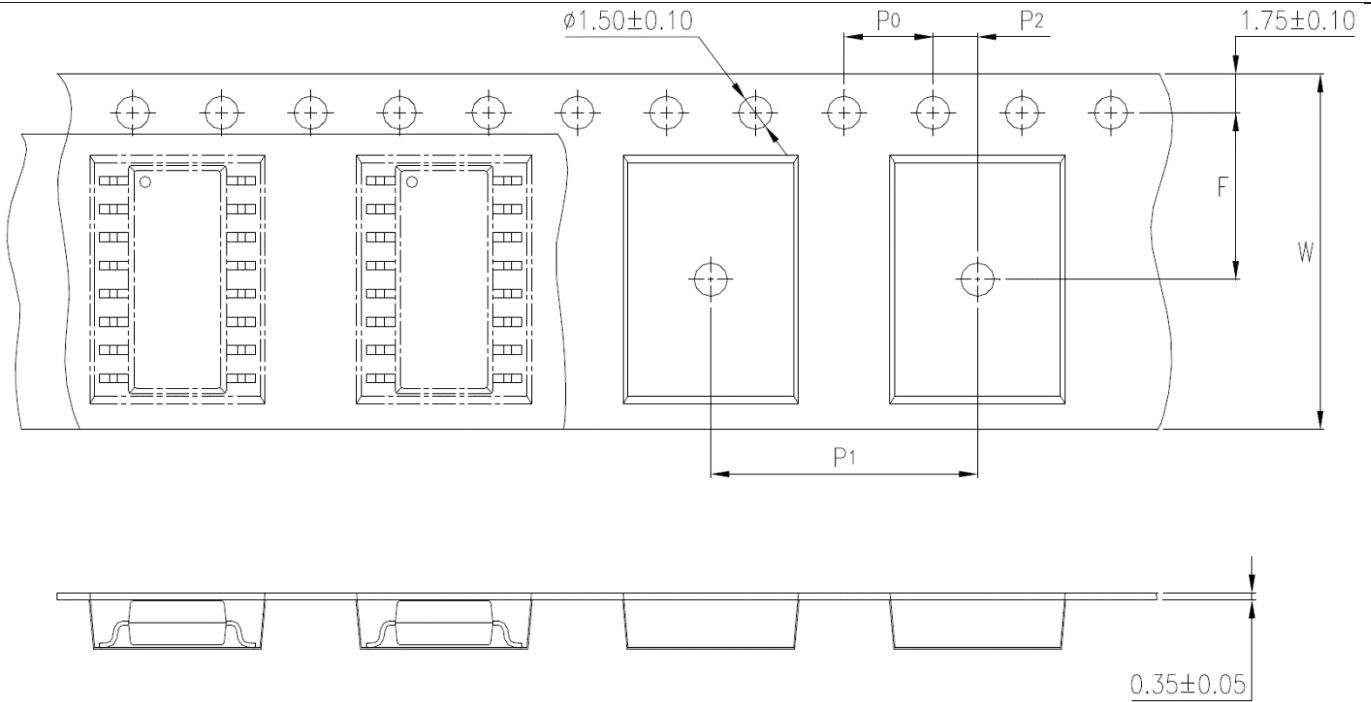
Recommended Solder Mask (Dimensions in mm unless otherwise stated)



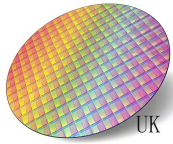


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option T1



Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P0	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
	P2	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P1	12 ± 0.1 (0.47)



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TLP280-4x:Part Number

I: denotes Company Abbr.

Y: denotes 1 digit Year code, Y=Year (A-2010, B-2011, ... , K-2020, L-2021)

WW: denotes 2 digit Week code

ORDERING INFORMATION

TLP280-4x

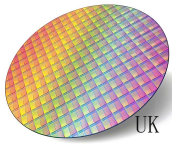
TLP – Series Abbr.

280-4 – Part Number

X – Rank (None/GB)

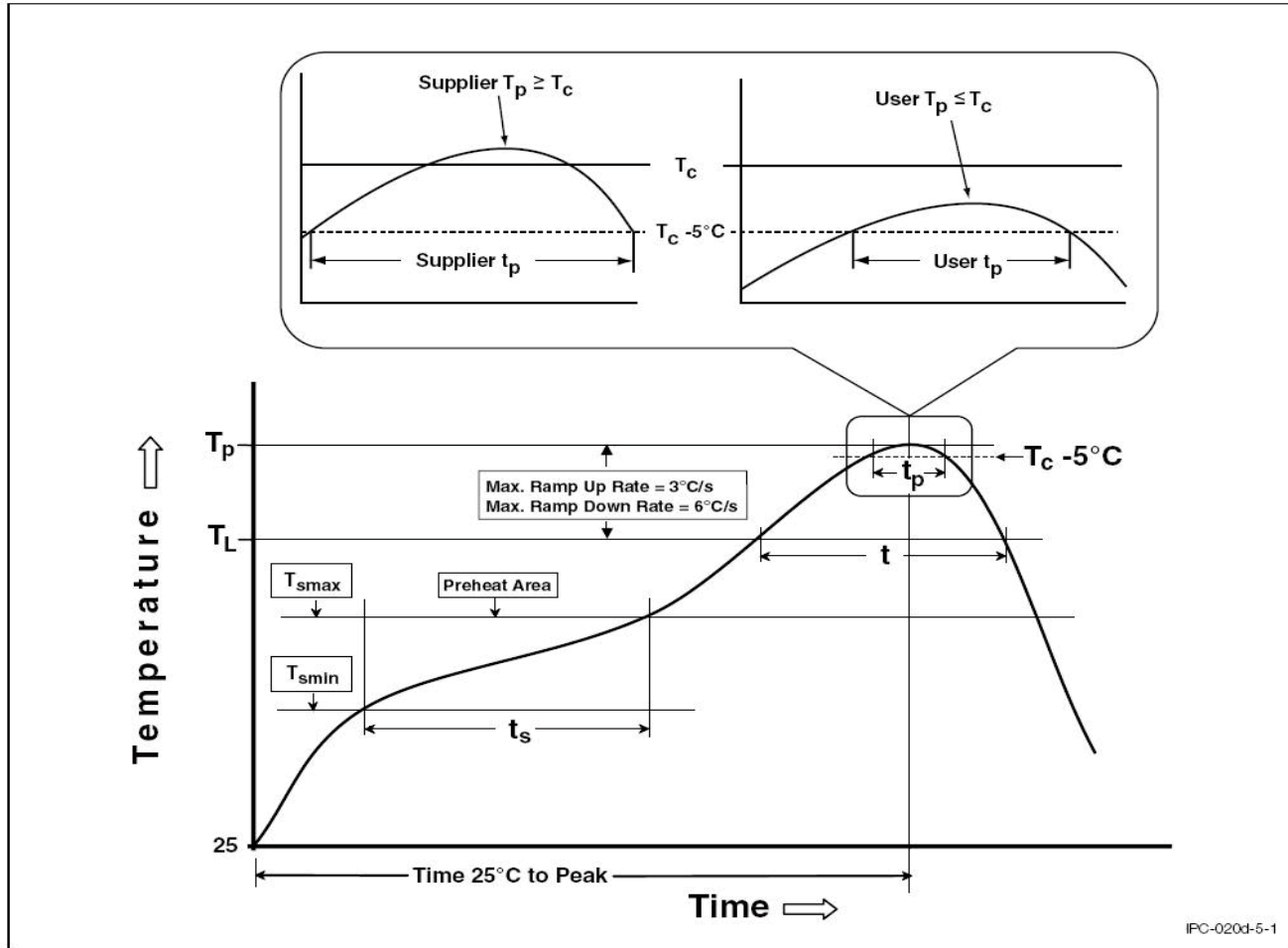
PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box
T1	2000 Units/Reel	4 Reels/Inner box	5 Inner box/Outer box = 20k Units



REFLOW INFORMATION

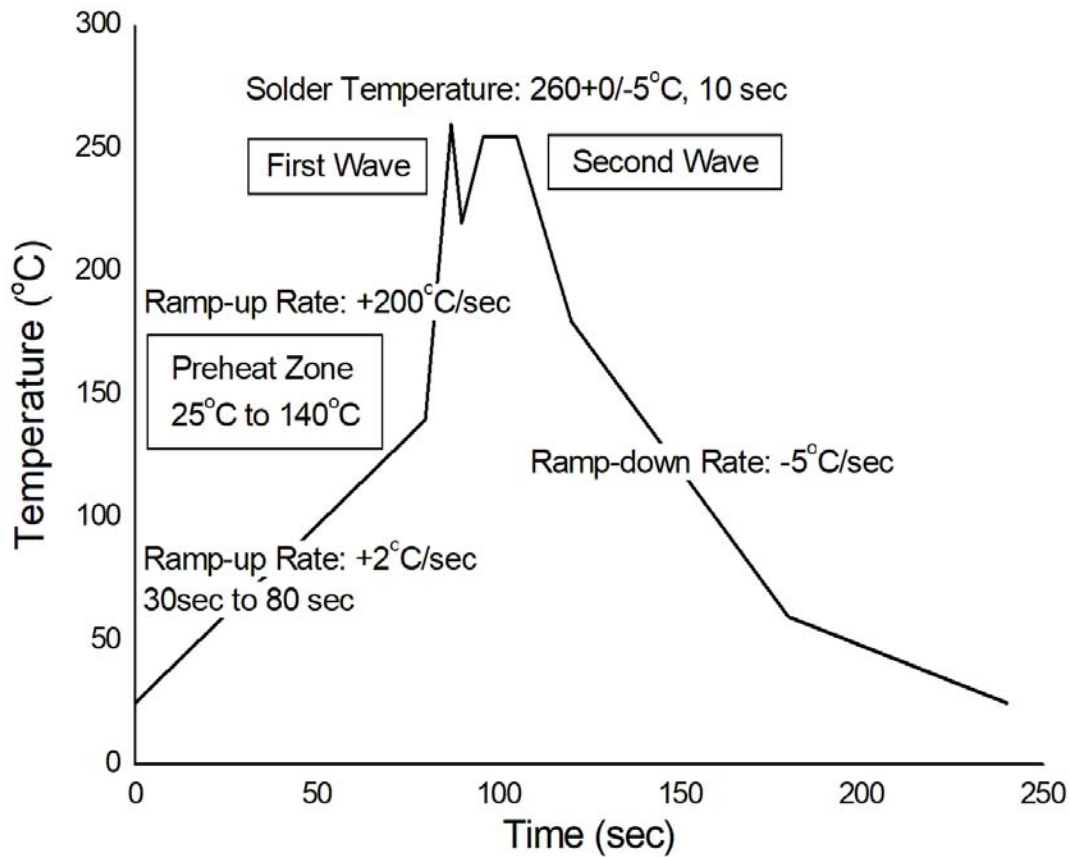
REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

TEMPERATURE PROFILE OF SOLDERING

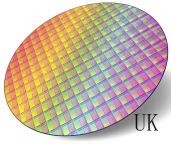
WAVE SOLDERING (JESD22-A111 COMPLIANT)



HAND SOLDERING BY SOLDERING IRON

Soldering Temperature	380+0/-5°C
Soldering Time	3 sec max.

- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



DISCLAIMER

- ASG is continually improving the quality, reliability, function and design. ASG reserves the right to make changes without further notices.
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This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
Please contact ASG sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
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Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It
- neither impacts the performance nor reliability.